



US00D871375S

(12) **United States Design Patent** (10) **Patent No.:** **US D871,375 S**
Meyer (45) **Date of Patent:** **** Dec. 31, 2019**

(54) **HEADPHONE**

(71) Applicant: **Harman International Industries, Incorporated**, Northridge, CA (US)

(72) Inventor: **Anna Grace Meyer**, Hannibal, MO (US)

(73) Assignee: **Harman International Industries, Incorporated**, Northridge, CA (US)

(**) Term: **15 Years**

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(51) **LOC (12) Cl.** **14-01**

(52) **U.S. Cl.**

USPC **D14/223**; D14/205

(58) **Field of Classification Search**

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D14/219, 221–225, 249, 372, 433, 138 R,
D14/182, 188, 191–194, 172, 496;
D29/112; D28/41; D2/875;
D24/173–175, 106; D3/294, 273;
D13/118, 108, 119
CPC H04R 25/02; H04R 25/00; H04R 1/10;
H04R 1/1016; H04R 1/105; H04R
1/1083; H04R 1/02; H04R 1/1041; H04R
1/28; H04R 5/033; H04R 2420/07; H04R
2430/00; H04R 2430/01
See application file for complete search history.

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Primary Examiner — Barbara Fox

Assistant Examiner — Mary Claire Ramirez

(74) *Attorney, Agent, or Firm* — Plumsea Law Group, LLC

(57) **CLAIM**

The ornamental design for a headphone, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of a headphone showing the new design;

FIG. 2 is a front elevational view thereof;

FIG. 3 is a rear elevational view thereof;

FIG. 4 is a top view thereof;

FIG. 5 is a bottom view thereof;

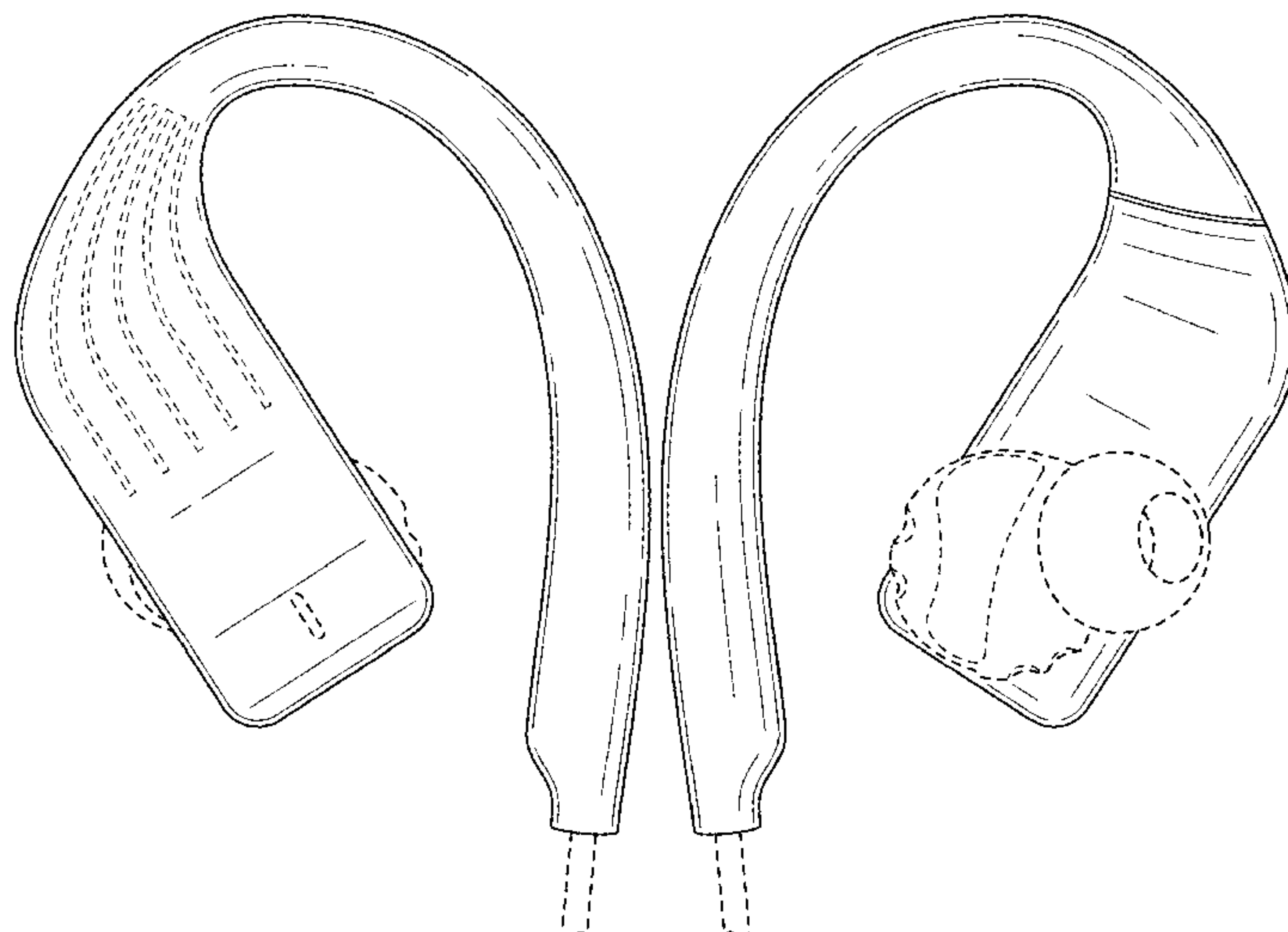
FIG. 6 is a side elevational view thereof; and,

FIG. 7 is an opposite side elevational view thereof.

The claim encompasses the mirror image embodiment thereof.

The broken lines shown in the drawings depict portions of the headphone that form no part of the claimed design.

1 Claim, 5 Drawing Sheets



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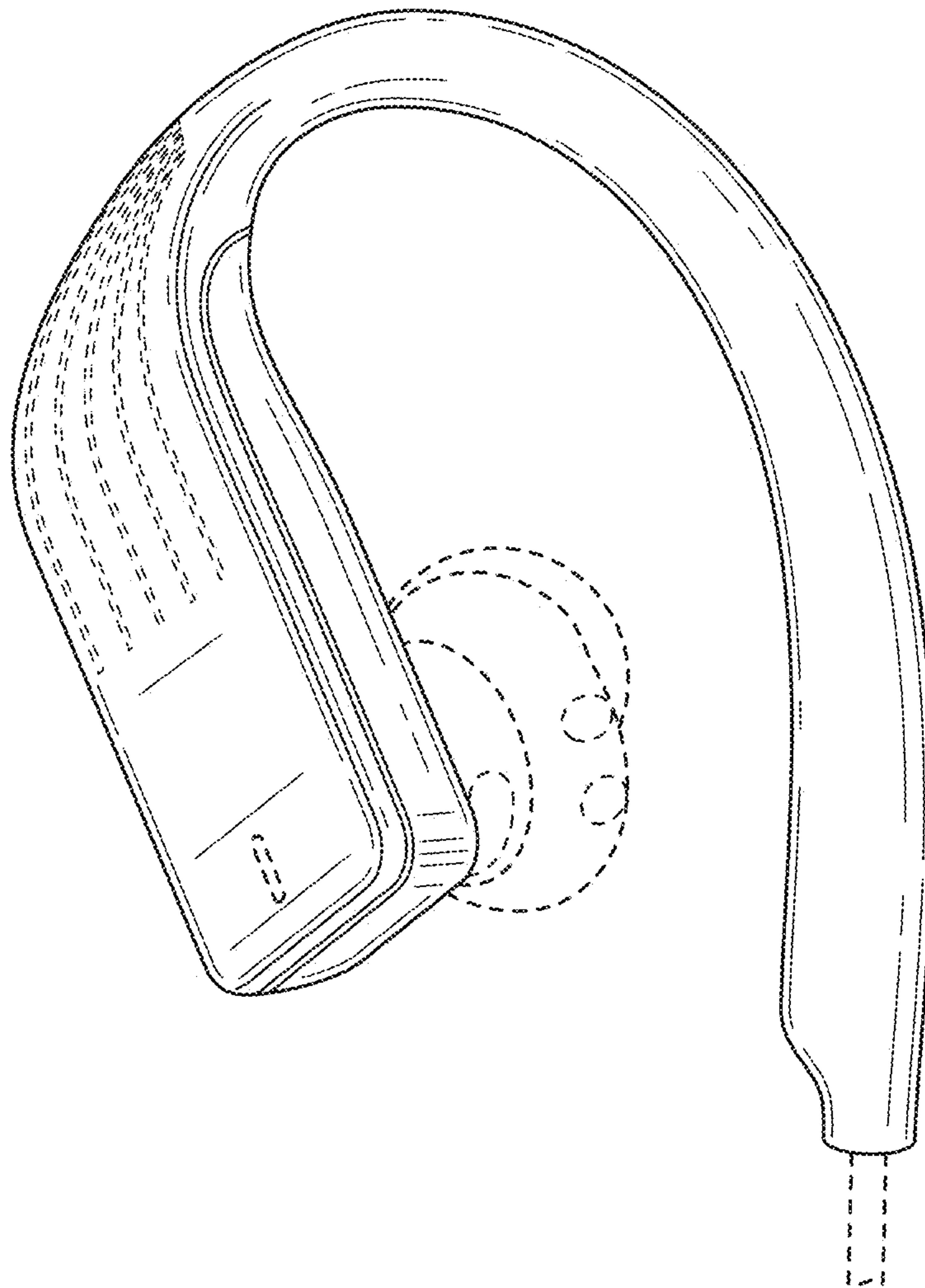


FIG. 1

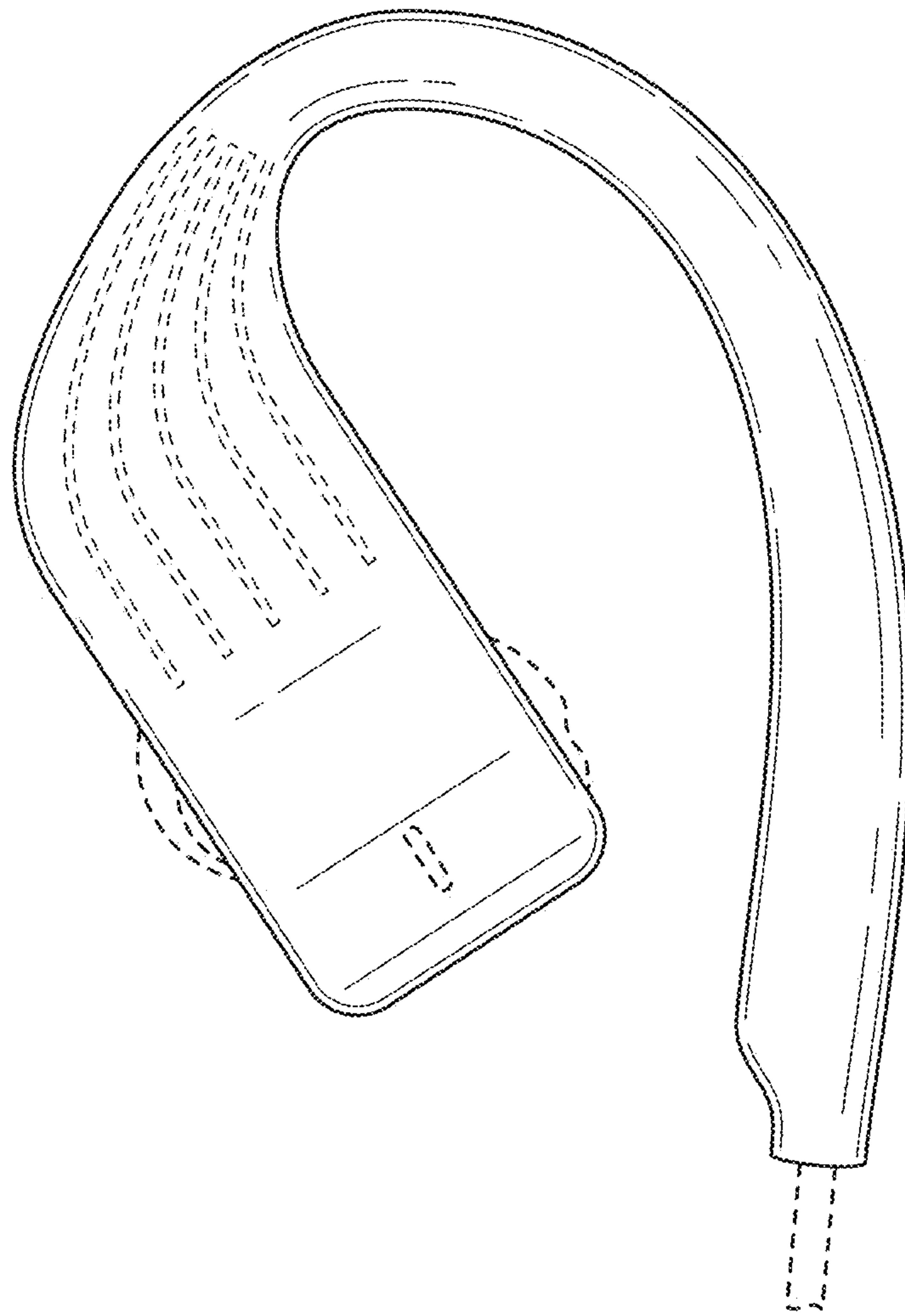


FIG. 2

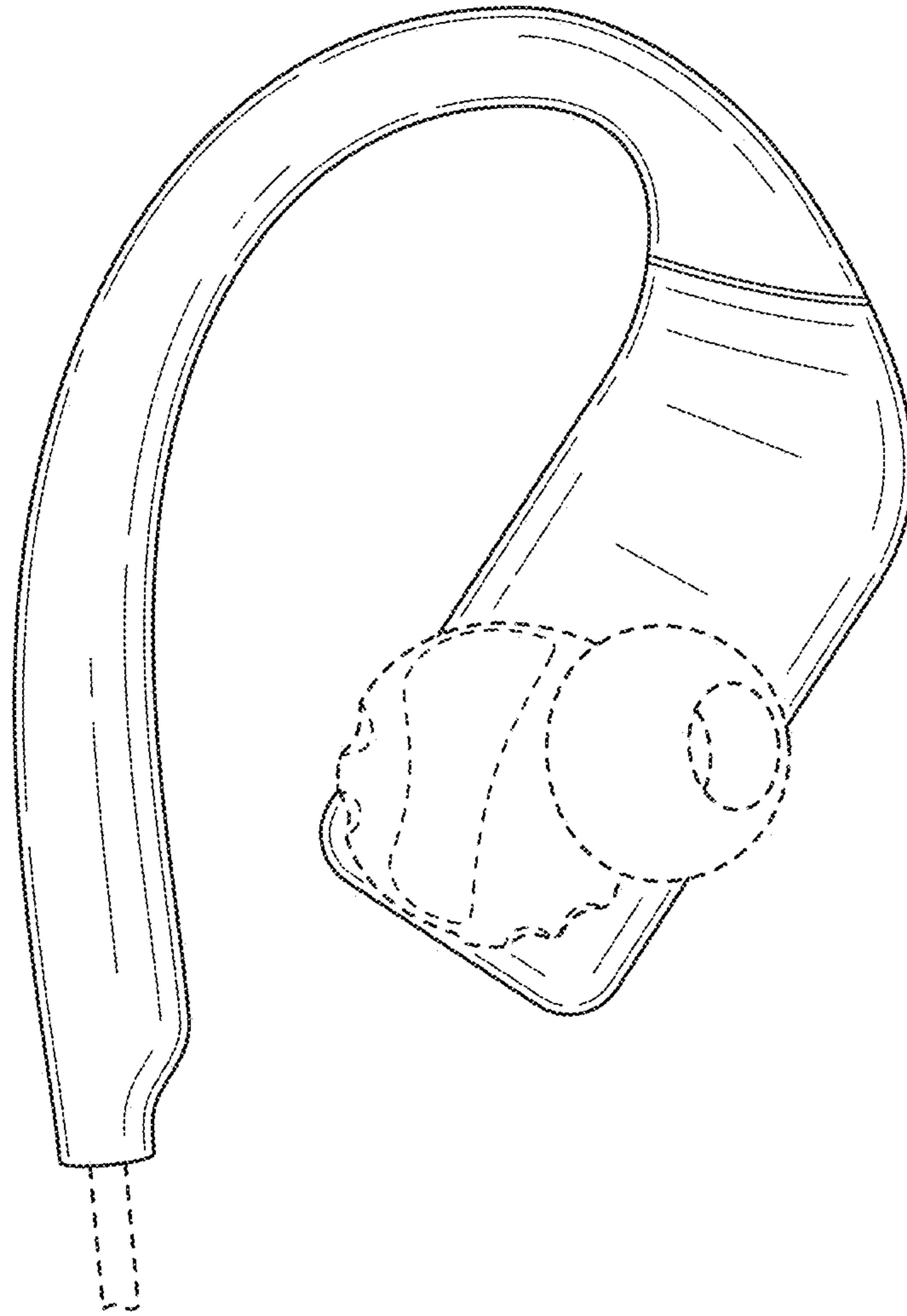


FIG. 3

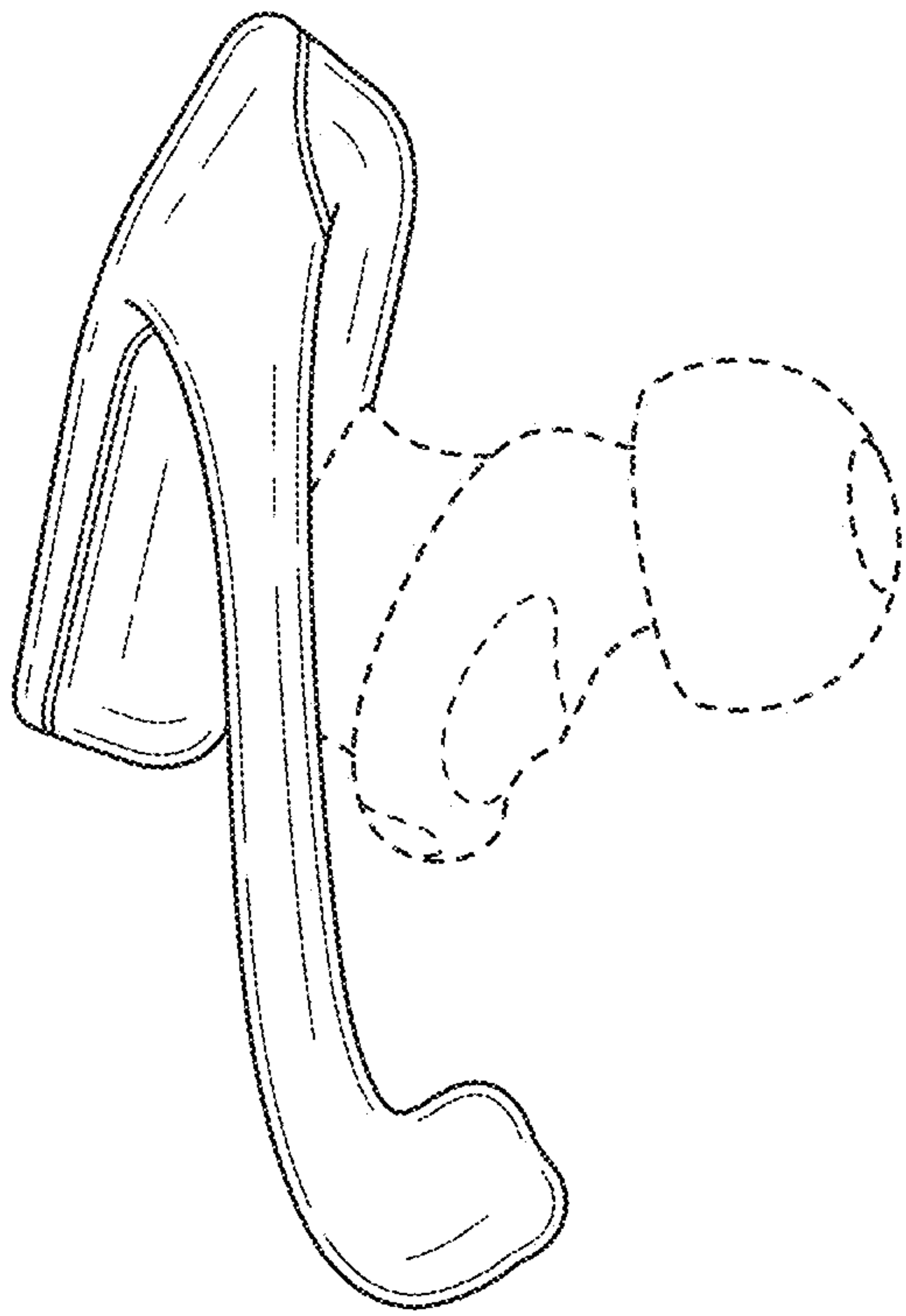


FIG. 4

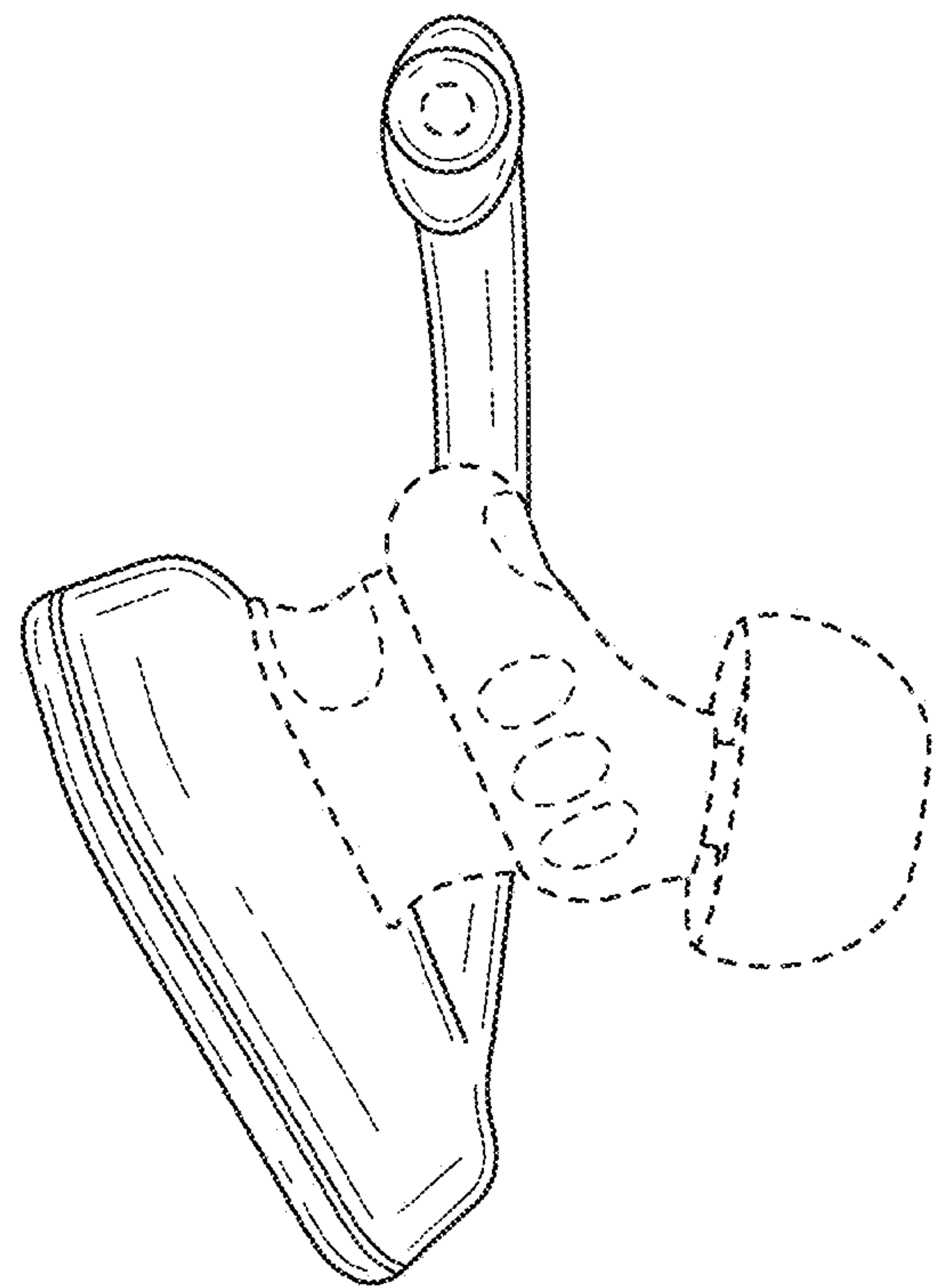


FIG. 5

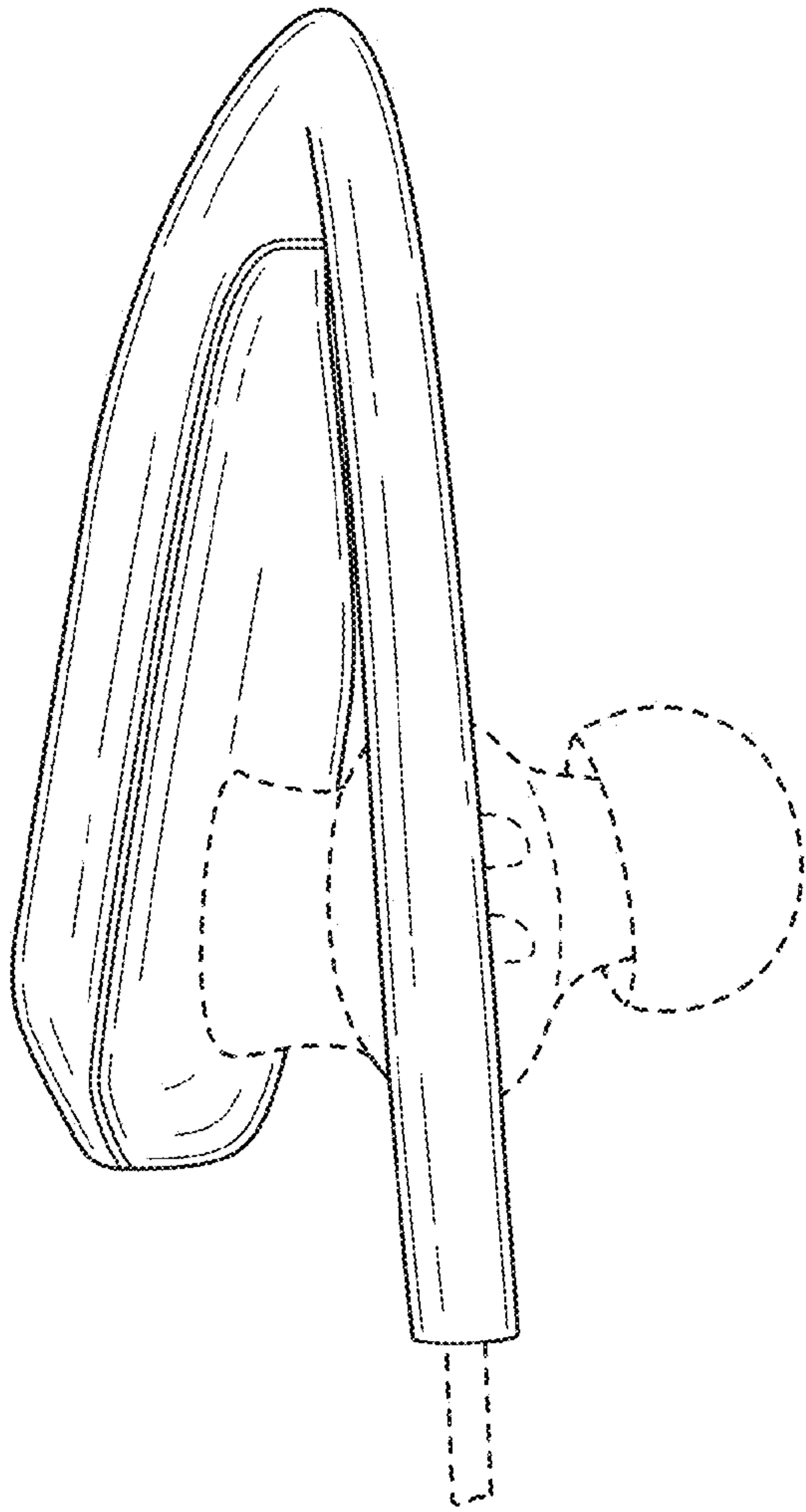


FIG. 6

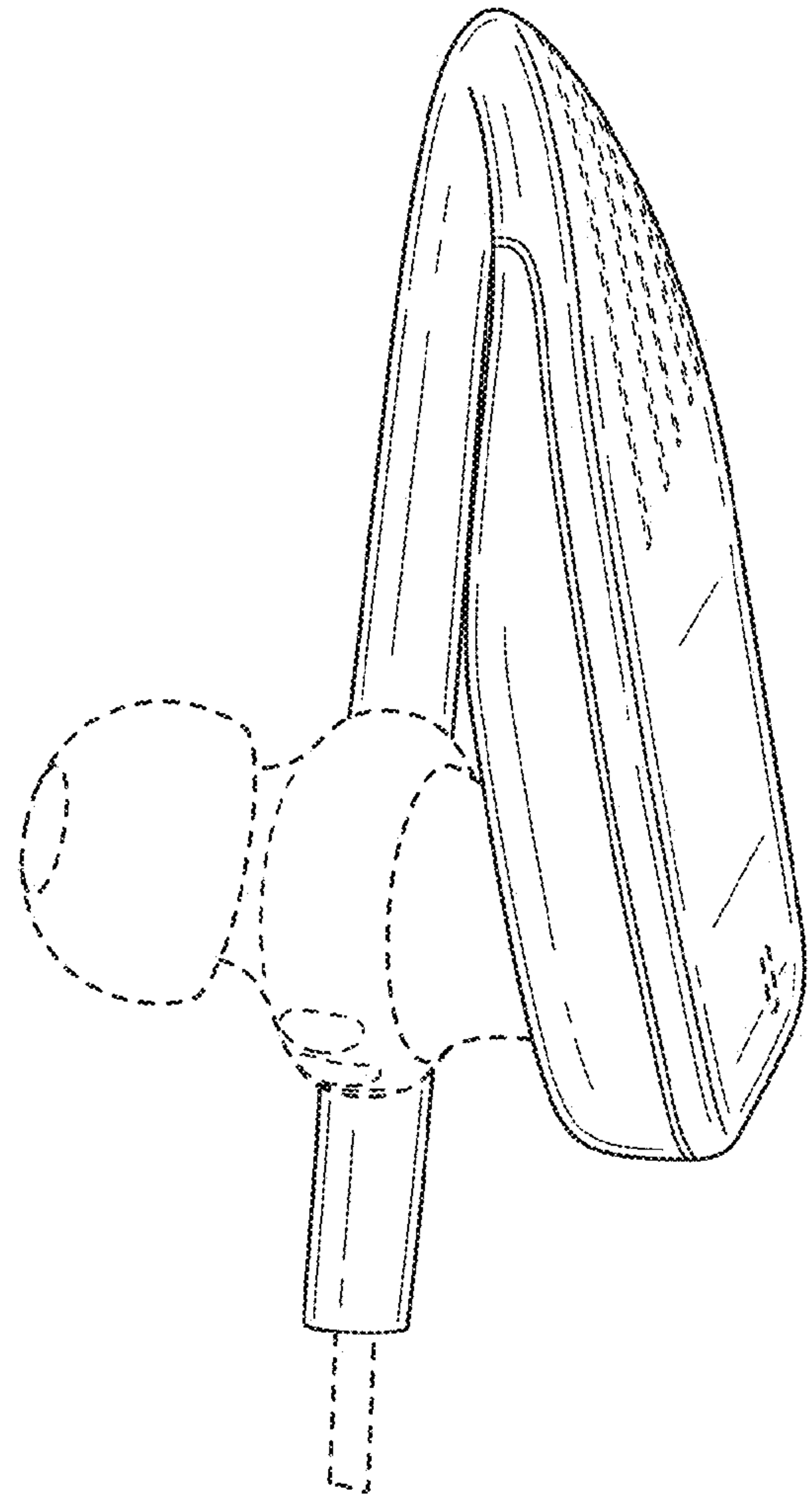


FIG. 7